# **BUFFER ISSUE RESOLUTION DOCUMENT (BIRD)**

<b>BIRD NUMBER:</b>	???				
<b>ISSUE TITLE:</b>	Power Pin Package Modeling				
<b>REQUESTOR:</b>	Arpad Muranyi, Mentor Graphics, Randy Wolff, Micron Technology				
	Inc.				
DATE SUBMITTED:	May ??, 2015				
DATE REVISED:	???				
DATE ACCEPTED BY IE	BIS OPEN FORUM: ???				

### **STATEMENT OF THE ISSUE:**

Under the [Package] keyword, the IBIS specification defines a set of rules on the hierarchy of the various package modeling options. It is clearly stated that when present, the package information under the [Pin] keyword will override the package information in the [Package] keyword, and if present the information in the [Package Model] and [Define Package Model] keywords will override the information in the [Pin] and [Package] keywords.

The rules for the [Pin Numbers] keyword in the [Define Package Model] keyword section do not prohibit a "partial package model", i.e., a model which only describes a subset of a Component's pins. The problem is that the IBIS specification does not define the hierarchy rules for the situation when the [Define Package Model] contains only a partial package model. In the absence of rules, model makers and EDA tool vendors may make different assumptions, which may lead to incorrect simulation results. For example, for missing package parasitics under the [Define Package Model] keyword one might assume that the package parasitics from the [Pin] or [Package] keyword should be used, but other assumptions might implement an open or short in such cases.

## ANALYSIS PATH/DATA THAT LED TO SPECIFICATION:

When creating coupled package models, it is in many cases desirable to reduce the number of pins associated with power and ground, as these pins are often connected to plane structures in the package. Merging power/ground pins results in a more compact model. When this type of package model is used in IBIS with the [Define Package Model] format using [Model Data] containing R, L and C matrices, many pin names may be omitted under the [Pin Numbers] keyword that are associated with power and ground connections.

Using the [Package]/[Pin] RLC data for *signal pins* not defined in [Define Package Model] is *expected*, however, *the same rule is difficult at best to apply to power and ground pins* and it seems that it may be better not to use RLC data from the [Package]/[Pin] keywords for some power and ground pins not defined in [Define Package Model].

For data in the [Pin] keyword, representing the capacitance of a plane on multiple pins is an issue. In addition, there is no way to define critically important mutual inductances and capacitances.

For data in the [Package] keyword, the problem revolves around the min/max values. People use the min/max values based on the signal's package parasitics, which is useless for the power/ground corner cases.

It seems that the only way to provide valid RLC data for power integrity (PI) simulations is by placing it into the [Define Package Model] keyword, and by merging multiple power/ground pins into one pin while leaving the remaining pins in the group undefined or disconnected.

A simple update to the IBIS specification proposed in this BIRD describes the rules that when the [Pin Mapping] keyword defines power/ground buses that span over multiple power/ground pins (i.e., pads), the package parasitics of those power/ground pins should be merged into a single pin representation per group in the [Define Package Model] keyword and only one of the pin names for each of those groups should be present in the [Pin Numbers] keyword of the [Define Package Model] keyword.

Even though the new package/on-die interconnect specification proposal for IBIS is expected to resolve these problems, it might still be worth adding this change for the legacy package modeling syntax, since there may be numerous models which will never use the new package modeling syntax.

The table below summarizes the package model rules that already exist in this specification or are proposed in this BIRD, including the addition of [Merged Pins].

POWER and GND PINS:						
[Component] Keyword Exists or Entries		[Define Package Model] Exists or Entries		EDA Tool Processing Expectation		
[Pin]	[Pin Mapping]	[Pin Numbers]	[Merged Pins]	Expected Pin Package Model Source		
(RLC)	NO	NO	**Illegal	RLC		
(RLC)	NO	YES	**Illegal	*[Define Package Model] for [Pin Numbers] pins		
				RLC for pins not in [Pin Numbers]		
(RLC)	YES	NO	**Illegal	RLC		
(RLC)	YES	YES	NO	*[Define Package Model] for [Pin Numbers] pins		
				Optional connection to other [Pin Numbers] pins on same [Pin Mapping] bus overriding RLC (EDA tool is expected to make connection through one or more [Pin Numbers] pins and not to use RLC)		
				RLC if NO [Pin Numbers] pin is declared from a [Pin Mapping] bus		
(RLC)	YES	YES	YES	[Model Data] ONLY for [Pin Numbers] pins, [Merged Pins] shorted to [Pin Numbers] pin on the same bus as documented		
				(All pins on [Merged Pins] keyword must be listed in the same [Pin Mapping] bus)		
				RLC if [Pin Numbers] contain NO pins from a [Pin Mapping] bus (This is permitted)		

Signal NC PIN	PINS for [Mode S (a generic pa	el]/[External Mo ackage model cou	del] dd document [De	fine Package Model] connections):		
[Component] Keyword Exists or Entries		[Define Package Model] Exists or Entries		EDA Tool Optional Processing Expectation		
[Pin]	[Pin Mapping]	[Pin Numbers]	[Merged Pins]	Expected Pin Package Model Source		
(RLC)	NO	NO	***Illegal	RLC		
(RLC)	NO	YES	***Illegal	*[Define Package Model] for [Pin Numbers] pins RLC model for pins not in [Pin Numbers]		
(RLC)	YES	NO	***Illegal	RLC		
(RLC)	YES	YES	***Illegal	*[Define Package Model] for [Pin Numbers] pins RLC model for pins not in [Pin Numbers]		
[Component] Keyword Exists or Entries		[Define Package Model] Exists or Entries		EDA Tool Optional Processing Expectation		
[Pin]	[Pin Mapping]	[Pin Numbers]	[Merged Pins]	Expected Pin Package Model Source		
(RLC)	****Illegal	NO	***Illegal	RLC		
(RLC)	****Illegal	YES	***Illegal	*[Define Package Model] for [Pin Numbers] pins RLC model for pins not in [Pin Numbers]		
Notes:						
[Pin] (RLC): L_pin/C_pin/R_pin or [Package] L_pkg/C_pkg/R_pkg for any missing L_pin/C_pin/R_pin						
*[Define Package Model]: [Number Of Sections] or [Model Data] formats are available **Illegal: For POWER and GND pins under the [Pin] keyword, [Merged Pins] requires BOTH [Pin Mapping]						
and [Pin Numbers] keywords ***Illegal: [Merged Pins] is illegal for Signal Pins, NC pins and CIRCUITCALL pins under [Pin] ****Illegal: [Pin Mapping] is also illegal with CIRCUITCALL pins under [Pin]						

#### ANY OTHER BACKGROUND INFORMATION:

This issue was discussed in a series of emails with Randy Wolff and Aniello Viscardi of Micron Technology, Inc. during the weeks of March, 2015. In addition, an extensive email conversation took place with Bob Ross and Radek Biernacki in the month of April, 2015 on the details of the rules and various test cases. The topic was also discussed in the March 31, April 7, and May 5, 2015 Advanced Technology Modeling Task Group Teleconferences. The proposal presented in this BIRD is based on all these discussions.

On pg. 137 add a new line to the table for the new proposed [Merged Pins] keyword as follows:

Keyword	Notes
[Define Package Model]	Required if the [Package Model] keyword is used
[Manufacturer]	(note 1)
[OEM]	(note 1)
[Description]	(note 1)
[Number Of Sections]	(note 2)
[Number Of Pins]	(note 1)
[Pin Numbers]	(note 1)
[Merged Pins]	Optional when [Model Data] is used
[Model Data]	(note 2)
[Resistance Matrix]	Optional when [Model Data] is used
[Inductance Matrix]	(note 3)
[Capacitance Matrix]	(note 3)
[Bandwidth]	Required (for Banded_matrix matrices only)
[Row]	(note 3)
[End Model Data]	(note 2)
[End Package Model]	(note 1)

Table 1 – Package Modeling Keywords

Note 1 Required when the [Define Package Model] keyword is used

Note 2 Either the [Number Of Sections] or the [Model Data]/[End Model Data] keywords are required. Note that [Number of Sections] and the [Model Data]/[End Model Data] keywords are mutually exclusive.

Note 3 Required when the [Define Package Model] keyword is used and the [Number Of Sections] keyword is not used.

On pg. 140 change the following paragraph under the [Pin Numbers] keyword:

*Usage Rules:* Following the [Pin Numbers] keyword, the names of the pins are listed. There must be as many names listed as there are pins (as given by the preceding [Number Of Pins] keyword). Pin names cannot exceed 5 characters in length. The first pin name given is the "lowest" pin, and the last pin given is the "highest." If the [Number Of Sections] keyword is used then each pin name must be followed by one or more of the legal subparameter combinations listed below. If the [Number Of Sections] keyword is not present then subparameter usage is NOT allowed.

to:

*Usage Rules:* Following the [Pin Numbers] keyword, the names of the pins are listed. There must be as many names listed as the number of pins given by the preceding [Number Of Pins] keyword, but it is not required to include all of the pins listed under the [Pin] keyword. Pin names cannot exceed 5 characters in length. The first pin name given is the "lowest" pin, and the last pin given is the "highest." If the [Number Of Sections] keyword is used then each pin name must be followed by one or more of the legal subparameter combinations listed below. If the [Number Of Sections] keyword is not present then subparameter usage is NOT allowed.

If a [Component] references a [Define Package Model] with the [Package Model] or an [Alternate Package Models] keyword, the EDA tool is expected to simulate the package parasitics of the pins in the component's [Pin] keyword that are not listed in the [Pin Numbers] keyword according to the hierarchy rules stated under the [Package] keyword.

However, if power/ground buses are defined by the [Pin Mapping] keyword of a component, the EDA tool is expected to provide the following option for the power/ground pins: If one or more pins from the power/ground bus defined by the [Pin Mapping] keyword are listed under the [Pin Numbers] keyword, then pins which are members of the same bus but are not listed under the [Pin Numbers] keyword shall NOT be simulated with their corresponding RLC values from the [Pin] or the [Package] keywords. Instead, these unlisted pins shall be shorted to the first pin of the bus that is listed under the [Pin Numbers] keyword. If more than one pin is listed, the EDA tool may provide a selection interface for the user to specify how the unlisted pins should be shorted with the listed pins. These options are provided to support merged power/ground pin package modeling without additional keywords. However, since the [Merged Pins] keyword (defined below) provides a mechanism to explicitly and unambiguously define how unlisted pins should be connected, the use of the [Merged Pins] keyword is strongly recommended for new models in which merged pin modeling exists.

If none of the power/ground pins of a bus defined in the [Pin Mapping] keyword appear under the [Pin Numbers] keyword, the EDA tool is expected to use the RLC values from the [Pin] or [Package] keywords according to the hierarchy rules stated under the [Package] keyword.

On pg. 142 add a new keyword description before the [Model Data] keyword as follows:

# Keyword: [Merged Pins]

*Required:* Optional when [Model Data] is used

*Description:* When the [Pin Mapping] keyword defines power/ground buses that span over multiple power/ground pins (i.e., pads), the package parasitics of one or more groups of power/ground pins may be merged into one or more single pin representations. The [Merged Pins] keyword declares the package model for the pin whose name follows the [Merged Pin] keyword as a merged package model and lists the names of the pins whose package parasitics have been merged into this merged package model.

*Usage Rules:* This keyword may optionally be used when the [Model Data] keyword is present in the [Define Package Model] section. When used, it must be placed after the end of the pin list defined by the [Pin Numbers] keyword and before the [Model Data] keyword. The keyword must be followed by one pin name on the same line on which the keyword appears, separated by at least one white space. This pin name must be listed under the [Pin Numbers] keyword, it must be listed as a POWER or GND pin under the [Pin] keyword and it must also be a member of a power or ground bus defined by the [Pin Mapping] keyword. This is the pin whose package model contains the merged package model data for a group of power or ground pins.

The line on which the [Merged Pins] keyword appears must be followed by a new line providing a list of one or more pin names, which are separated by at least one white space. The list may be on a single line or span multiple lines and is terminated by either another [Merged Pins] keyword or the [Model Data] keyword.

Each pin name in the list must match the name of a POWER or GND pin in the [Pin] keyword and must also be a member of the same power or ground bus of which the pin that follows the [Merged Pins] keyword is a member, but pin names in this list must not be present in the pin list under the [Pin Numbers] keyword. In other words, the pins in the list should not have a package model defined under the [Define Package Model] keyword. The list must include the name of all those pins whose package parasitics have been merged into the pin that follows the [Merged Pins] keyword. No pin name may appear more than once under all [Merged Pins] keywords.

When pin names of a power/ground bus defined by the [Pin Mapping] keyword do not appear under the [Pin Numbers] or [Merged Pins] keywords, while at least one or more pin names of the same bus are listed under the [Pin Numbers] keyword, the EDA tool is expected to apply the rules stated under the [Pin Numbers] keyword. That is, the EDA tool is expected to provide an option for the user to either use the RLC values from the [Pin] or the [Package] keywords for the unlisted pins, or to short them to the first listed pin under the [Pin Numbers] keyword, or to provide an interface for the user to define their connections. This shall be done regardless of whether the pin name that is listed first under the [Pin Numbers] keyword appears under any one of the [Merged Pins] keywords or not. The option of using the RLC values instead of shorting unlisted pins to those present in [Pin Numbers] should be excluded if at least one [Merged Pins] keyword is present for any power/ground bus. Model makers are strongly encouraged to produce models in which every pin that is a member of a bus is listed under the [Pin Numbers] and/or the [Merged Pins] keywords. The EDA tool is expected to connect all of the pins (not die pads) named in the [Merged Pins] keyword together with an ideal short.

*Other Notes:* Note that power integrity (PI) analysis including the package parasitics on power and ground nets is not possible with Components which do not contain power/ground bus definitions using the [Pin Mapping] keyword together with the [Define Package Model] keyword, because key pieces of information on how power is distributed between the power and ground pins and the power terminals of buffer [Model]s are not available for the EDA tool. For PI analysis, at least one power/ground pin should be included in [Pin Numbers] from each power/ground bus defined in [Pin Mapping] for a given signal pin's buffer. If no power/ground pins are defined, ideal power/ground connections based on the [Voltage Range] and/or the [\* Reference] keywords can be assumed. However, there is insufficient information for PI analysis.

#### Example:

[Manufacturer] ACME, Inc. [OEM] ACME, Inc. [Description] FBGA Package Model for x4 Data Pins and POWER/GND [Number of Pins] 13 [Pin Numbers] A1 |VDD A2 |VSSQ A8 |VSSQ A9 |VSS B2 |VDDQ B3 |DQS c B7 |D01 C2 |DQ0 C3 |DQS t C7 |VDD D3 | DQ2 D7 |DQ3 D9 |VSSQ [Merged Pins] A1 H1 M1 | Merged VDD [Merged Pins] C7 F9 J9 N9 | Merged VDD (electrically in parallel with A1, shorted at the die) [Merged Pins] A9 C8 E9 G1 H9 K1 K9 N1 | Merged VSS [Merged Pins] A2 D1 | Merged VSSQ (electrically in parallel with A8 and D9, shorted at the die) [Merged Pins] B2 B8 C1 C9 E2 E8 | Merged VDDQ